# BLC2425M10LS250

# Power LDMOS transistor Rev. 2 — 26 July 2018

**AMMPLEON** 

Product data sheet

#### **Product profile** 1.

### 1.1 General description

250 W LDMOS-based power transistor suitable for use in a variety of commercial and consumer cooking, industrial, scientific and medical applications at frequencies from 2400 MHz to 2500 MHz.

The BLC2425M10LS250 is designed for high-power CW applications and is assembled in a high performance plastic package.

**Typical performance** Table 1.

RF performance at  $V_{DS}$  = 32 V;  $I_{Dq}$  = 100 mA;  $T_{case}$  = 25 °C in a class-AB application circuit.

Test signal	f	V <sub>DS</sub>	P <sub>L(AV)</sub>	Gp	η <sub>D</sub>
	(MHz)	(V)	(W)	(dB)	(%)
CW	2450	32	260	15.2	68.5
CW pulsed [1]	2450	32	260	15.3	68.8

<sup>[1]</sup>  $t_p = 100 \ \mu s; \ \delta = 10 \%.$ 

#### 1.2 Features and benefits

- High efficiency
- Excellent ruggedness
- Integrated ESD protection
- Designed for broadband operation (2400 MHz to 2500 MHz)
- Internally input and output matched
- For RoHS compliance see the product details on the Ampleon website

### 1.3 Applications

 RF power amplifiers for CW applications in the 2400 MHz to 2500 MHz frequency range such as commercial and consumer cooking, industrial, scientific and medical applications

### 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	drain		
2	gate	1 .	1 
flange	source	2 "	2 3 3 sym112

### 3. Ordering information

Table 3. Ordering information

Type number	Packag	Package		
	Name	Description	Version	
BLC2425M10LS250	-	air cavity plastic earless flanged package; 2 leads	SOT1270-1	

### 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage		-	65	V
$V_{GS}$	gate-source voltage		-6	+13	V
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature	[1]	-	225	°C

<sup>[1]</sup> Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

### 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{\text{th(j-case)}}$	thermal resistance from junction to case	$T_{case} = 80  ^{\circ}C;  P_{L} = 250  W$	0.33	K/W

### 6. Characteristics

Table 6. DC characteristics

 $T_i$  = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 2.7 \text{ mA}$	65.00	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$V_{DS} = 32 \text{ V}; I_{D} = 20 \text{ mA}$	1.68	2.15	2.68	V
I <sub>DSS</sub>	drain leakage current	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 32 V	-	-	2.8	μΑ
I <sub>DSX</sub>	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	-	59.7	-	A
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 11 V; V <sub>DS</sub> = 0 V	-	-	280	nA
9 <sub>fs</sub>	forward transconductance	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 15.2 A	-	22.6	-	S
R <sub>DS(on)</sub>	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 10.64 \text{ A}$	-	40.5	-	mΩ

#### Table 7. RF characteristics

Test signal: pulsed at 2450 MHz; RF performance at  $V_{DS}$  = 32 V;  $I_{Dq}$  = 10 mA;  $T_{case}$  = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	P <sub>L</sub> = 260 W	13.2	14.4	-	dB
RLin	input return loss	P <sub>L</sub> = 260 W	-	-15	<b>-</b> 5	dB
$\eta_{D}$	drain efficiency	P <sub>L</sub> = 260 W	64	68.7	-	%

### 7. Test information

#### 7.1 Ruggedness in class-AB operation

The BLC2425M10LS250 is capable of withstanding a load mismatch corresponding to VSWR = 20 : 1 through all phases with a time rate of 55 ms/degree under the following conditions:  $V_{DS}$  = 32 V;  $I_{Dq}$  = 10 mA;  $P_{L}$  = 260 W (CW);  $I_{Dq}$  = 2450 MHz;  $I_{Case}$  = 25 °C.

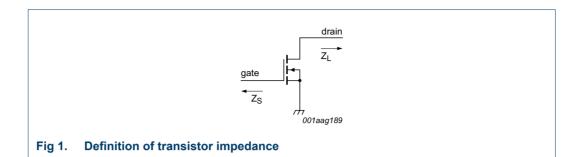
### 7.2 Impedance information

#### Table 8. Typical impedance

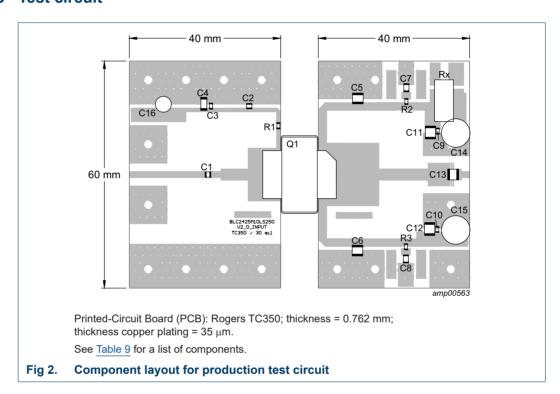
Measured load-pull data. Typical values unless otherwise specified.  $I_{Dq}$  = 10 mA;  $V_{DS}$  = 32 V.

f	Z <sub>S</sub> [1]	Z <sub>L</sub> [1]
(MHz)	(Ω)	(Ω)
2400	3.43 – 6.80j	2.31 – 2.00j
2450	3.31 – 6.57j	2.14 – 1.70j
2500	3.20 - 6.29j	1.98 – 1.43j

[1]  $Z_S$  and  $Z_L$  defined in Figure 1.



#### 7.3 Test circuit



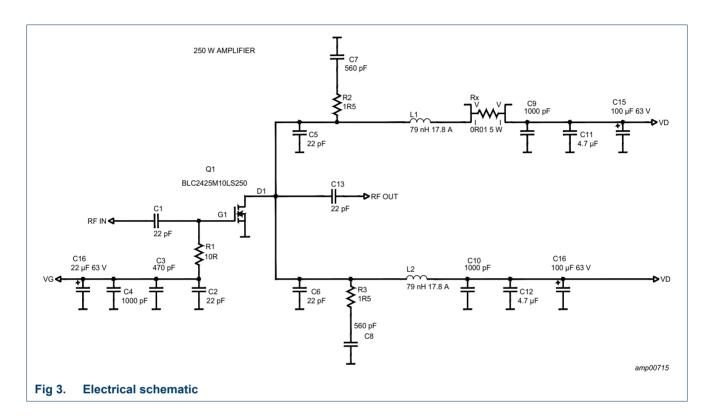
**Table 9. List of components** See Figure 2 for component layout.

Component	Description	Value	Remarks
C1, C2	multilayer ceramic chip capacitor	22 pF	ATC 800A
C3, C9, C10	multilayer ceramic chip capacitor	1000 pF, 50 V	C0805
C4	multilayer ceramic chip capacitor	1 μF, 50 V	C1206
C5, C6, C13	multilayer ceramic chip capacitor	22 pF	ATC 800B
C7, C8	multilayer ceramic chip capacitor	560 pF	ATC 100B
C11, C12	multilayer ceramic chip capacitor	4.7 μF, 50 V	C1210
C14, C15	electrolytic capacitor	100 μF, 63 V	
C16	electrolytic capacitor	22 μF, 63 V	
L1, L2	inductor	79 nH, 17.8 A [1]	1010VS-79NMEB
Q1	LDMOS transistor		BLC2425M10LS250

**Table 9.** List of components ...continued See Figure 2 for component layout.

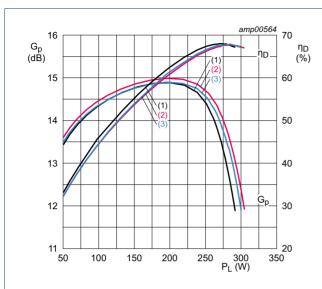
Component	Description	Value	Remarks
R1	chip resistor	10 Ω	R0603
R2, R3	chip resistor	1.5 Ω	R1206
Rx	shunt resistor	0.01 Ω	Ohmite: FC4L110R010FER

[1] Optional component.



amp00565

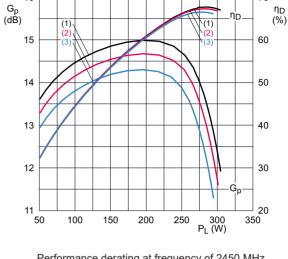
### 7.4 Graphical data



 $V_{DS} = 32 \text{ V}; I_{Dq} = 10 \text{ mA}.$ 

- (1) f = 2400 MHz
- (2) f = 2450 MHz
- (3) f = 2500 MHz

Fig 4. Power gain and drain efficiency as function of output power; typical values



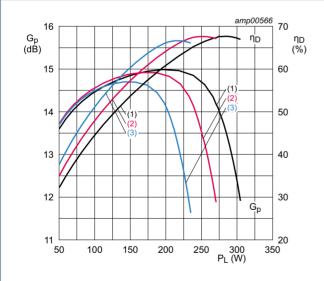
Performance derating at frequency of 2450 MHz.  $V_{DS}$  = 32 V;  $I_{Dq}$  = 10 mA.

(1)  $T_{case} = 25 \, ^{\circ}C$ 

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- (2)  $T_{case} = 45 \, ^{\circ}C$
- (3)  $T_{case} = 65 \, ^{\circ}C$

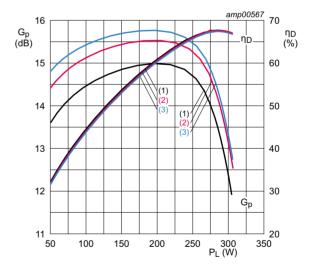
Fig 5. Power gain and drain efficiency as function of output power; typical values



Performance derating at frequency of 2450 MHz.  $I_{Dq} = 10$  mA.

- (1)  $V_{DS} = 32 V$
- (2)  $V_{DS} = 30 \text{ V}$
- (3)  $V_{DS} = 28 \text{ V}$

Fig 6. Power gain and drain efficiency as function of output power; typical values



Performance derating at frequency of 2450 MHz.  $V_{DS}$  = 32 V.

- (1)  $I_{Dq} = 10 \text{ mA}$
- (2)  $I_{Dq} = 50 \text{ mA}$
- (3)  $I_{Dq} = 100 \text{ mA}$

Fig 7. Power gain and drain efficiency as function of output power; typical values

### 8. Package outline

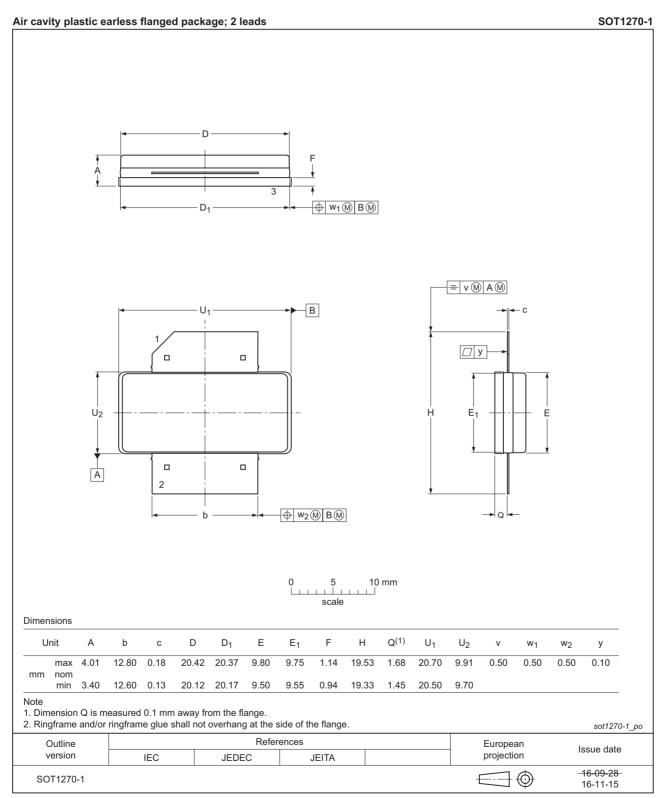


Fig 8. Package outline SOT1270-1

### 9. Handling information

#### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 10. ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C1 [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	1C [2]

- [1] CDM classification C1 is granted to any part that passes after exposure to an ESD pulse of 250 V.
- [2] HBM classification 1C is granted to any part that passes after exposure to an ESD pulse of 1000 V.

### 10. Abbreviations

Table 11. Abbreviations

Acronym	Description	
CW	Continuous Wave	
ESD	ElectroStatic Discharge	
LDMOS	aterally Diffused Metal-Oxide Semiconductor	
MTF	Median Time to Failure	
RoHS	Restriction of Hazardous Substances	
VSWR	Voltage Standing Wave Ratio	

### 11. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLC2425M10LS250 v.2	20180726	Product data sheet	-	BLC2425M10LS250 v.1
Modifications	Table 1 on page 1: table updated			
	• Figure 2 on p	age 4: figure updated		
	• Figure 3 on p	age 5: figure updated		
	Table 9 on pa	ge 4: table updated		
BLC2425M10LS250 v.1	20180710	Product data sheet	-	-

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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### BLC2425M10LS250

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#### **Power LDMOS transistor**

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